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HMC306MS10/306MS10E

v06.0206





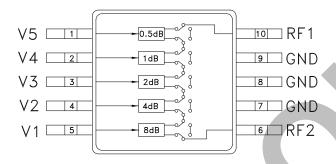
0.5 dB LSB GaAs MMIC 5-BIT DIGITAL ATTENUATOR, 0.7 - 3.8 GHz

Typical Applications

The HMC306MS10 / HMC306MS10E is ideal for:

- Cellular; UMTS/3G Infrastructure
- ISM, MMDS, WLAN, WiMAX
- Microwave Radio & VSAT
- Test Equipment and Sensors

Functional Diagram



Features

RoHS-Compliant Product 0.5 dB LSB Steps to 15.5 dB Single Positive Control Per Bit

± 0.2 dB Typical Bit Error

Miniature 15 mm² Package: MSOP10

Included in the HMC-DK004 Designer's Kit

General Description

The HMC306MS10 & HMC306MS10E are general purpose broadband 5-bit positive control GaAs IC digital attenuators in 10 lead MSOP surface mount plastic packages. Covering 0.7 to 3.8 GHz, the insertion loss is typically less than 1.5 to 2.3 dB. These attenuators' bit values are 0.5 (LSB), 1, 2, 4 and 8 dB for a total attenuation of 15.5 dB. Attenuation accuracy is excellent at ± 0.2 dB typical with an IIP3 of up to +52 dBm. Five bit control voltage inputs, toggled between 0 and +3 to +5V, are used to select each attenuation state. A single Vdd bias of +3 to +5V applied through an external 5K Ohm resistor is required.

Electrical Specifications,

 $T_A = +25^{\circ}$ C, Vdd = +3V to +5V & VCTL = 0/Vdd (Unless Otherwise Stated)

Parameter		Frequency (GHz)	Min.	Typical	Max.	Units
Insertion Loss		0.7 - 1.4 1.4 - 2.3 2.3 - 2.7 2.7 - 3.8		1.3 1.5 1.8 2.3	1.6 2.0 2.5 2.7	dB dB dB dB
Attenuation Range				15.5		dB
Return Loss (RF1 & RF2, All Atten. States)		0.7 - 1.4 1.4 - 2.3 2.3 - 2.7 2.7 - 3.8	15 14 13 10	21 18 16 13		dB dB dB dB
Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States 0.5 - 7.5 dB States 8.0 - 15.5 dB States All Attenuation States		0.7 - 1.4 1.4 - 2.3 1.4 - 2.3 2.3 - 3.8	$ \begin{array}{l} \pm \ (0.30 + 5\% \ \text{of Atten. Setting) Max.} \\ \pm \ (0.25 + 3\% \ \text{of Atten. Setting) Max.} \\ \pm \ (0.15 + 3\% \ \text{of Atten. Setting) Max.} \\ \pm \ (0.30 + 3\% \ \text{of Atten. Setting) Max.} \end{array} $			dB dB dB dB
Input Power for 0.1 dB Compression	Vdd = 5V Vdd = 3V	0.7 - 3.8		25 23		dBm dBm
Input Third Order Intercept Point (Two-tone Input Power = 0 dBm Each Tone)	Vdd = 5V Vdd = 3V	0.7 - 3.8		52 48		dBm dBm
Switching Characteristics						
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)		0.7 - 3.8		560 600		ns ns

ANALOGDEVICES

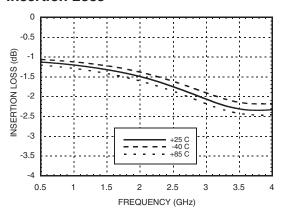
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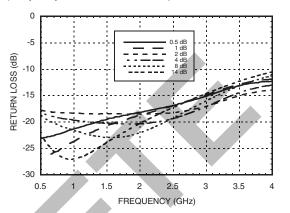


Insertion Loss



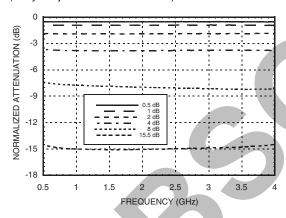
Return Loss RF1, RF2

(Only Major States are Shown)

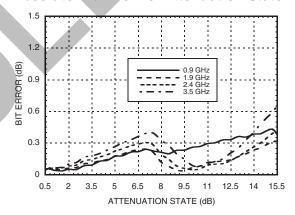


Normalized Attenuation

(Only Major States are Shown)

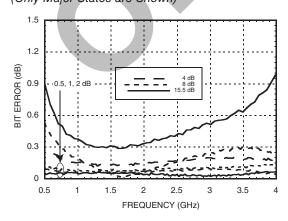


Absolute Bit Error vs. Attenuation State



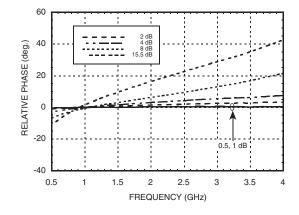
Absolute Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)





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Truth Table

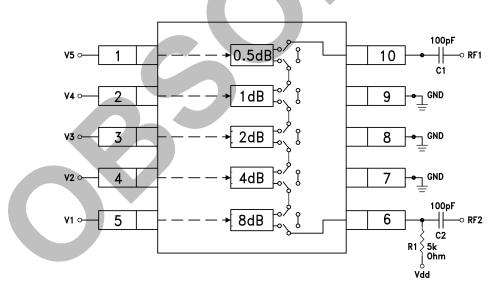
Control Voltage Input					Attenuation	
V1 8 dB	V2 4 dB	V3 2 dB	V4 1 dB	V5 0.5 dB	State RF1 - RF2	
High	High	High	High	High	Reference I.L.	
High	High	High	High	Low	0.5 dB	
High	High	High	Low	High	1 dB	
High	High	Low	High	High	2 dB	
High	Low	High	High	High	4 dB	
Low	High	High	High	High	8 dB	
Low	Low	Low	Low	Low	15.5 dB Max. Atten.	

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

Control & Bias Voltages

State	Bias Condition	
Low	0 to +0.2V @ 20 μA Max.	
High Vdd ± 0.2V @ 20 μA Max.		
Note: $Vdd = +3V \text{ to } 5V \pm 0.2V$		

Application Circuit



Note:

DC Blocking Capacitors C1 & C2 are required on RF1 & RF2. Choose C1 = $C2 = 100 \sim 300$ pF to allow lowest customer specific frequency to pass with minimal loss. R1= 5K Ohm is required to supply voltage to the circuit through either Pin 6 or Pin 10.



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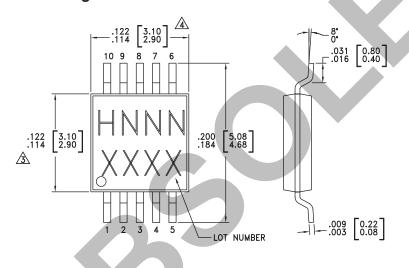
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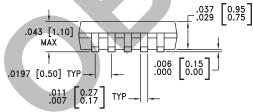
Absolute Maximum Ratings

Control Voltage (V1 - V5)	Vdd + 0.5 Vdc
Bias Voltage (Vdd)	+8.0 Vdc
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
RF Input Power (0.7 - 3.8 GHz)	+28 dBm
ESD Sensitivity (HBM)	Class 1A



Outline Drawing





NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].

DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

△ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.

5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC306MS10	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H306 XXXX
HMC306MS10E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H306 XXXX

^[1] Max peak reflow temperature of 235 °C

^[2] Max peak reflow temperature of 260 °C

^{[3] 4-}Digit lot number XXXX

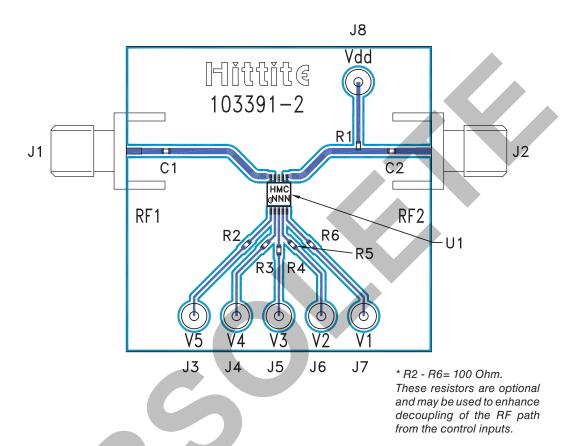


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Evaluation Circuit Board



List of Materials for Evaluation PCB 103393 [1]

Item		Description		
J1 - J2		PCB Mount SMA Connector		
J3 - J8		DC Pin		
R1	,	5k Ohm Resistor, 0402 Pkg.		
R2 - R6		100 Ohm Resistor, 0402 Pkg.		
C1 - C2		0402 Chip Capacitor, Select Value for Lowerst Frequency		
U1		HMC306MS10 / HMC306MS10E Digital Attenuators		
PCB [2]		103391 Evaluation PCB 1.5" x 1.5"		

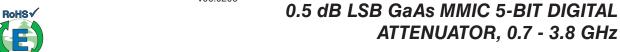
[1] Reference this number when ordering complete evaluation $\ensuremath{\mathsf{PCB}}$

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



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Notes:

